



Corpay to Participate in Upcoming Investor Conferences

November 6, 2025

ATLANTA--(BUSINESS WIRE)--Nov. 6, 2025-- Corpay, Inc., (NYSE: CPAY), the corporate payments company, today announced that the Company will participate in the following investor conferences:

- On Wednesday, November 12, 2025, the Company will be attending the KBW FinTech Payments Conference in New York, NY. Management will participate in a fireside chat beginning at 11:40 AM ET.
- On Monday, November 17, 2025, the Company will be attending the Rothschild & Co. Redburn's FinTech Conference in Miami, FL.
- On Tuesday, November 18, 2025, the Company will be attending Citi's 14th Annual FinTech Conference in New York, NY.
- On Tuesday, December 2, 2025, the Company will be attending the UBS Global Technology and AI Conference in Scottsdale, AZ. Management will participate in a fireside chat beginning at 3:35 PM ET.

Investors and interested parties can access these presentations by visiting the Company's investor relations website at <https://investor.corpay.com/>.

About Corpay

Corpay (NYSE: CPAY), the Corporate Payments Company, is a global S&P 500 provider of commercial cards (e.g, business cards, fleet cards, virtual cards) and AP modernization solutions (e.g., invoice and payments automation, cross border payments) to businesses worldwide. Corpay solutions "keep business moving" and result in our customers better controlling purchases, mitigating fraud, and ultimately spending less. To learn more visit www.corpay.com.

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Corpay Investor Relations

Jim Eglseder
Jim.Eglseder@corpay.com
770-417-4697

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